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UPS560e3

5 A Schottky Barrier Rectifier

DESCRIPTION

This UPS560e3 in the Powermite3® package is a high efficiency Schottky rectifier that is also RoHS compliant offering high current/power capabilities previously found only in much larger packages. They are ideal for SMD applications that operate at high frequencies. In addition to its size advantages, the Powermite3® package includes a full metallic bottom that eliminates the possibility of solder flux entrapment during assembly and a unique locking tab act as an efficient heat path to the heat-sink mounting. Its innovative design makes this device ideal for use with automatic insertion equipment.

IMPORTANT: For the most current data, consult MICROSEMI's website: http://www.microsemi.com

ABSOLUTE MAXIMUM RATINGS AT 25° C (UNLESS OTHERWISE SPECIFIED)

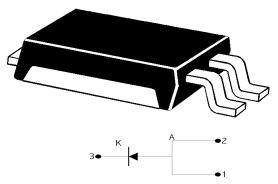
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$egin{array}{c} egin{array}{c} egin{array}{c} V_{RMM} \ V_{R} \end{array}$	60	V
RMS Reverse Voltage	V _{R (RMS)}	42	V
Average Rectified Output Current	Io	5	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine wave Superimposed on Rated Load@ T _c =90 °C	I _{FSM}	100	А
Storage Temperature	T_{STG}	-55 to +150	°C
Junction Temperature	T_J	-55 to +125	°C

THERMAL CHARACTERISTICS

Thermal Resistance	_		
Junction-to-case (bottom)	R _{eJC}	3.2	°C/ Watt
Junction to ambient (1)	Raia	65	°C/ Watt

(1) When mounted on FR-4 PC board using 2 oz copper with recommended minimum foot print

Powermite 3™



Note: 1 Short duration test pulse used to minimize self – heating effect.

KEY FEATURES

- Very low thermal resistance package
- RoHS Compliant with e3 suffix part number
- Guard-ring-die construction for transient protection
- Efficient heat path with Integral locking bottom metal tab
- Low forward voltage
- Full metallic bottom eliminates flux entrapment
- Compatible with automatic insertion
- Low profile-maximum height of 1mm

APPLICATIONS/BENEFITS

- Switching and Regulating Power Supplies.
- Silicon Schottky (hot carrier) rectifier for minimal reverse voltage recovery
- Elimination of reverse-recovery oscillations to reduce need for EMI filtering
- Charge Pump Circuits
- Reduces reverse recovery loss with low I_{RM}
- Small foot print
 190 X 270 mils (1:1 Actual size)
 See mounting pad details on pg 3

MECHANICAL & PACKAGING

- CASE: Void-free transfer molded thermosetting epoxy compound meeting UL94V-0
- FINISH: Annealed matte-Tin plating over copper and readily solderable per MIL-STD-750 method 2026 (consult factory for Tin-Lead plating)
- POLARITY: See figure (left)
- MARKING: S560•
- WEIGHT: 0.072 gram (approx.)
- Package dimension on last page
- Tape & Reel option: 16 mm tape per Standard EIA-481-B, 5000 on 13" reel

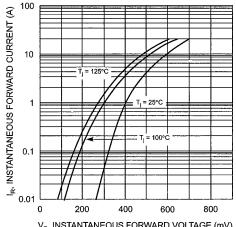


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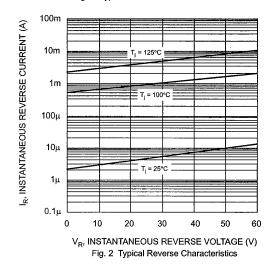
5 A Schottky Barrier Rectifier

ELECTRICAL PARAMETERS @25°C (unless otherwise specified)								
Parameter	Symbol	Conditions	Min	Тур.	Max	Units		
Forward Voltage (Note 1)	V _{Fm}	$I_F = 5 \text{ A}$, $T_j = 25 \text{ °C}$ $I_F = 5 \text{ A}$, $T_j = 125 \text{ °C}$ $I_F = 8 \text{ A}$, $T_j = 25 \text{ °C}$ $I_F = 8 \text{ A}$, $T_i = 125 \text{ °C}$		0.65 0.56 0.74 0.64	0.69 0.60 0.78 0.68	V		
Reverse Break Down Voltage (Note 1)	V _{BR}	I _R = 0.2 mA	60	0.04	0.00	V		
Reverse Current (Note1)	Im	V _R = 60 V, T _j = 25°C V _R = 60 V, T _j =125 °C		2 0.6	200 20	μA mA		
Capacitance	Ст	$V_R = 4 \text{ V}; F = 1 \text{ MH}_Z$		150		pF		

GRAPHS



 V_{F} , INSTANTANEOUS FORWARD VOLTAGE (mV) Fig. 1 Typical Forward Characteristics



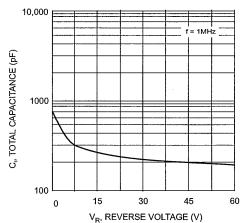
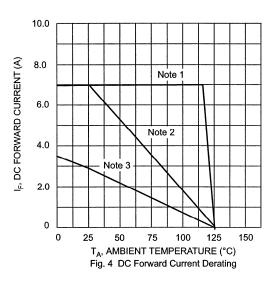


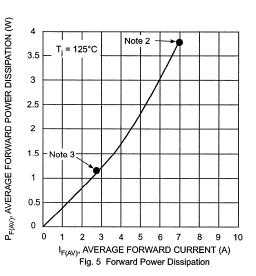
Fig. 3 Typical Capacitance vs. Reverse Voltage



UPS560e3

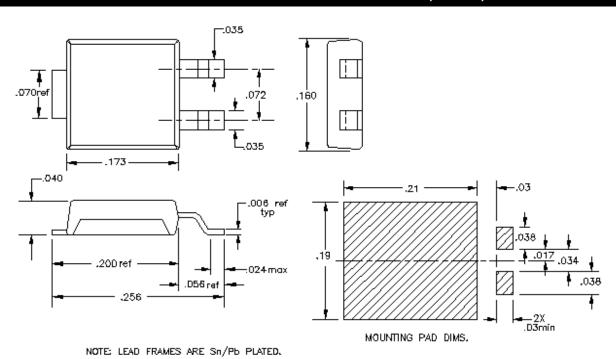
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- NOTE 1: $T_A = T_C$ at case bottom where $R_{\theta JC} = 2.5^{\circ}$ C/W and $R_{\theta CA} = 0^{\circ}$ C/W (infinite heat sink).
- NOTE 2: Device mounted on GETEK substrate, 2" x 2", 2 oz. copper , double-sided , cathode pad dimensions 0.75" x 1.0", anode pad dimensions 0.25" x 1.0". $R_{\theta JA}$ in range of 20-35° C/W.
- NOTE 3: Device mounted on FRA-4 substrate, 2" x 2", 2 oz. copper, single-sided, pad layout R_{0JA} in range of 65°C/W. See

PACKAGE & MOUNTING PAD DIMENSIONS (inches)



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